

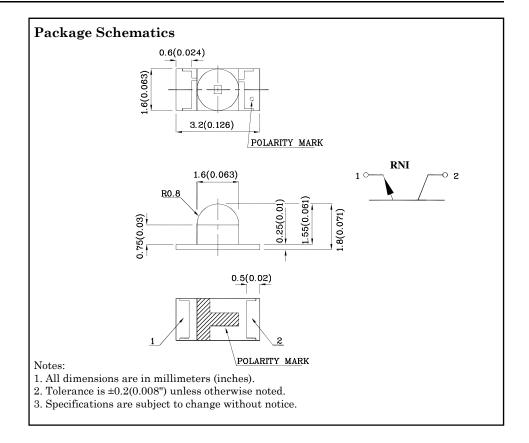
3.2x1.6mm PHOTOTRANSISTOR

Features

- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- \bullet MSL (Moisture Sensitivity Level): 3
- RoHS compliant







Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condiction
VBR CEO	Collector-to-Emitter Breakdown Voltage	30			V	Ic=100μA Ee=0mW/cm²
VBR ECO	Emitter-to-Collector Breakdown Voltage	5			V	IE=100μA Ee=0mW/cm²
VCE(SAT)	Collector-to-Emitter Saturation Voltage			0.8	V	IC=2mA Ee=20mW/cm ²
ICEO	Collector Dark Current			100	nA	VCE=10V Ee=0mW/cm ²
TR	Rise Time (10% to 90%)		15		μs	Vce=5V Ic=1mA Rl=1KΩ
T_{F}	Fall Time (90% to 10%)		15		μs	
I(ON)	On State Collector Current	0.4	1		mA	$V_{\rm CE=5V}$ $Ee=1{\rm mW/cm^2}$ $\lambda=940{\rm nm}$

Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Ratings		
Collector-to-Emitter Voltage	30V		
Emitter-to-Collector Voltage	5V		
Power Dissipation at (or below) 25°C Free Air Temperature	100mW		
Operating / Storage Temperature Range	-40°C To +85°C		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Oct 12,2016 XDSA8822 V5 Layout: Maggie L.





Typical Electro-Optical Characteristics Curves

 $\begin{tabular}{ll} Fig. 1 & Collector & Power Dissipation & vs. \\ & Ambient Temperature & \\ \end{tabular}$

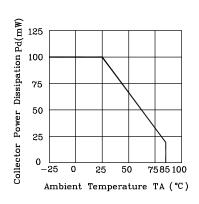


Fig.2 Spectral Sensitivity

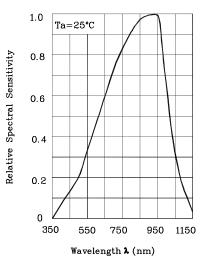


Fig.3 Relative Collector Current vs.
Ambient Temperature

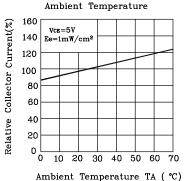


Fig.4 Collector Current Ic=f(Ec), Vce=5V, Ta=25°C

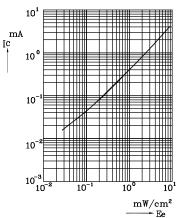


Fig.5 Collector Dark Current vs.
AmbientTemperature

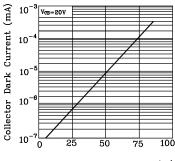
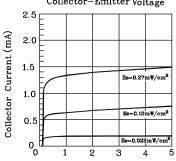


Fig. 6 CollectorCurrent vs.
Collector-Emitter Voltage



Collector-Emitter Voltage VCE (V)

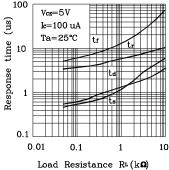
Ambient Temperature TA (°C)



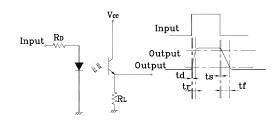


Fig.7 Response Time vs.
Load Resistance

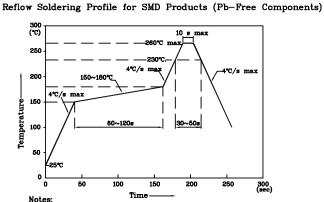
100
Vcs=5V
Ic=100 uA



Test Circuit for Response Time

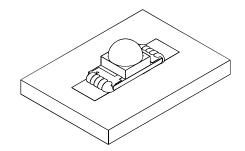


LED is recommended for reflow soldering and soldering profile is shown below.

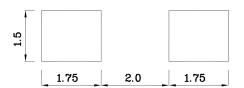


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: $145^{\circ}C-260^{\circ}C$
- 3. Do not put stress to the epoxy resin during high temperatures conditions

❖ The device has a single mounting surface. The device must be mounted according to the specifications.

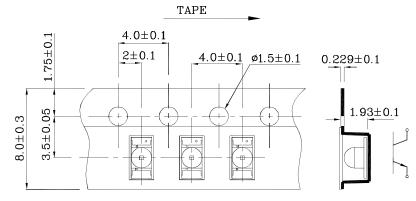


♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

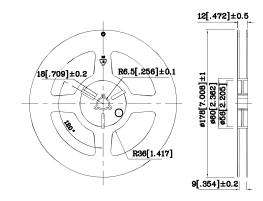


❖ Tape Specification (Units:mm)

Tupe specification (Circle Circle)



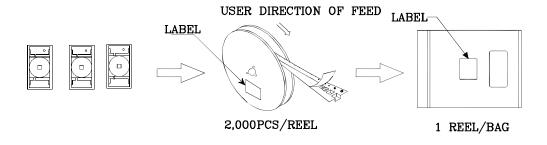
Reel Dimension

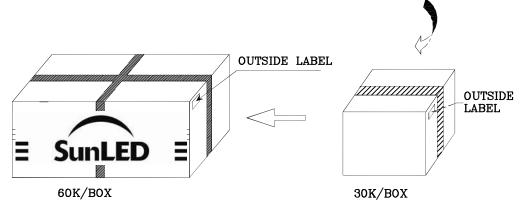


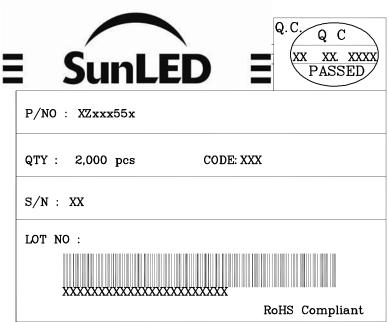




PACKING & LABEL SPECIFICATIONS







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